CLAIM AMENDMENTS

1 - 29. (canceled)

30. (new) A method of making an electronic component having a chip module with module contacts and an antenna having antenna contacts, the method comprising the steps of:

securing the chip module and module contacts to the inner face of a module film having an outer periphery projecting past the chip module and module contacts;

securing the antenna and antenna contacts to a face of a support;

pressing the module film against the support such that the module contacts engage and bear on the antenna contacts; and

bonding the outer periphery to the face of the support generally all around the chip module.

31. (new) The method defined in claim 30 wherein the contacts of the chip module or of the antenna have points so that when pressed against the other contacts they penetrate the other contacts.

32. (new) The method defined in claim 31 wherein the pointed contacts are of pyramidal shape.

33. (new) The method defined in claim 32 wherein each pointed contact is formed by a multiplicity of particles.

34. (new) The method defined in claim 33 wherein the particles are nickel-coated diamond particles.

35. (new) The method defined in claim 30 wherein the module film is an elongated strip carrying a plurality of the module chips and their respective module contacts at a uniform predetermined module spacing, the method further comprising the step of:

longitudinally subdividing the strip into film sections each of which is of a length equal to the predetermined module spacing.

36. (new) The method defined in claim 35 wherein the support to whose face the antenna and antenna contacts are secured is a surface of packaging.

37. (new) The method defined in claim 35 wherein the support to whose face the antenna and antenna contacts are secured is an elongated strip carrying a plurality of the antennas and the respective antenna contacts at a predetermined uniform antenna spacing that is substantially greater than the module spacing.

38. (new) The method defined in claim 37 wherein the longitudinal subdivision of the strip carrying the modules is carried out before pressing the film sections against the respective antenna on its strip.

39. (new) The method defined in claim 38, further comprising the step, after longitudinally subdividing the strip carrying the modules, of longitudinally spacing the film sections by the antenna spacing.

40. (new) The method defined in claim 37, wherein the strip carrying the modules is pressed against the strip carrying the antennas before longitudinally subdividing the strip, the longitudinal subdivision of the strip carrying the modules being carried out by removing pieces of the module strip between succeeding modules.

41. (new) The method defined in claim 37, further comprising the step of

coating the antenna strip with adhesive prior to pressing the module strip against the antenna strip.

42. (new) The method defined in claim 41 wherein the coating with adhesive is only done to discrete regions of the antenna strip adjacent the antenna contacts.

43. (new) The method defined in claim 42 wherein the discrete regions have a size generally corresponding to the module spacing.

44. (new) The method defined in claim 37, further comprising the steps of

releasably mounting the module strip on a mounting strip;

separating the mounting strip from the module strip prior to securing thereto the modules and module contacts; and

releasably securing the modules directly to the mounting strip at least after longitudinal subdivision of the module strip.

45. (new) The method defined in claim 44 wherein the modules are releasably secured to the mounting strip before longitudinal subdivision of the module strip and the longitudinal subdivision of the module strip is carried out by removing pieces of the module strip between the modules.

46. (new) The method defined in claim 37, further comprising the step of

rolling up the antenna strip after pressing the module film against the antenna strip forming the support.

47. (new) The method defined in claim 46, further comprising the step prior to rolling up the antenna strip of

inspecting the modules.

48. (new) The method defined in claim 47, further comprising the step after inspecting the modules of marking any modules failing inspection.

49. (new) The method defined in claim 37, further comprising the step of

releasably adhering a mounting strip to a face of the antenna strip turned away from the module strip.

50. (new) The method defined in claim 37, further comprising the step of

releasably adhering a mounting strip to faces of the module strip turned away from the antenna strip and to exposed portions of the face of the antenna strip between adjacent film sections.

51. (new) The method defined in claim 30 wherein the module is associated with two respective module contacts and the module is secured to the film between the two respective contacts.

52. (new) The method defined in claim 30 wherein the module film is flexible and of plastic.